



# BAT165A

40 V, 0.75 A medium power Schottky barrier rectifier

2 May 2016

Product data sheet

## 1. General description

Medium power Schottky barrier rectifier with an integrated guard ring for stress protection, encapsulated in a very small SOD323 (SC-76) Surface-Mounted Device (SMD) plastic package.

## 2. Features and benefits

- Forward current:  $I_F \leq 0.75$  A
- Reverse voltage:  $V_R \leq 40$  V
- Low forward voltage typ.  $V_F = 640$  mV
- Low reverse current typ.  $I_R = 1.5$   $\mu$ A
- Very small SMD plastic package
- AEC-Q101 qualified

## 3. Applications

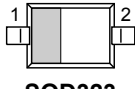

- Low voltage rectification
- High efficiency DC-to-DC conversion
- Switch mode power supply
- Reverse polarity protection
- Low power consumption application
- Automotive applications

Table 1. Quick reference data

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$I_F$	forward current	$T_{sp} \leq 93$ °C; $\delta = 1$	-	-	0.75	A
$V_R$	reverse voltage	$T_j = 25$ °C	-	-	40	V
$V_F$	forward voltage	$I_F = 750$ mA; $t_p \leq 300$ $\mu$ s; $\delta \leq 0.02$ ; $T_j = 25$ °C	-	640	740	mV
$I_R$	reverse current	$V_R = 40$ V; pulsed; $T_j = 25$ °C	-	1.5	8	$\mu$ A
		$V_R = 40$ V; pulsed; $T_j = 65$ °C	-	30	900	$\mu$ A

## 4. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	K	cathode	 SOD323	 sym001
2	A	anode		

## 5. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
BAT165A	SOD323	plastic surface-mounted package; 2 leads	SOD323

## 6. Marking

Table 4. Marking codes

Type number	Marking code
BAT165A	2G

## 7. Limiting values

Table 5. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
$V_R$	reverse voltage	$T_j = 25\text{ °C}$		-	40	V
$I_F$	forward current	$T_{sp} \leq 93\text{ °C}$ ; $\delta = 1$		-	0.75	A
$I_{F(AV)}$	average forward current	50 Hz $\leq$ f $\leq$ 60 Hz; $T_{amb} \leq 93\text{ °C}$ ; pulsed sinusoidal		-	0.5	A
$I_{FSM}$	non-repetitive peak forward current	$t_p = 8\text{ ms}$ ; $T_{j(init)} = 25\text{ °C}$ ; square wave		-	8	A
$P_{tot}$	total power dissipation	$T_{amb} \leq 25\text{ °C}$	[1]	-	380	mW
			[2]	-	555	mW
$T_j$	junction temperature			-	150	°C
$T_{amb}$	ambient temperature			-55	150	°C
$T_{stg}$	storage temperature			-65	150	°C

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.

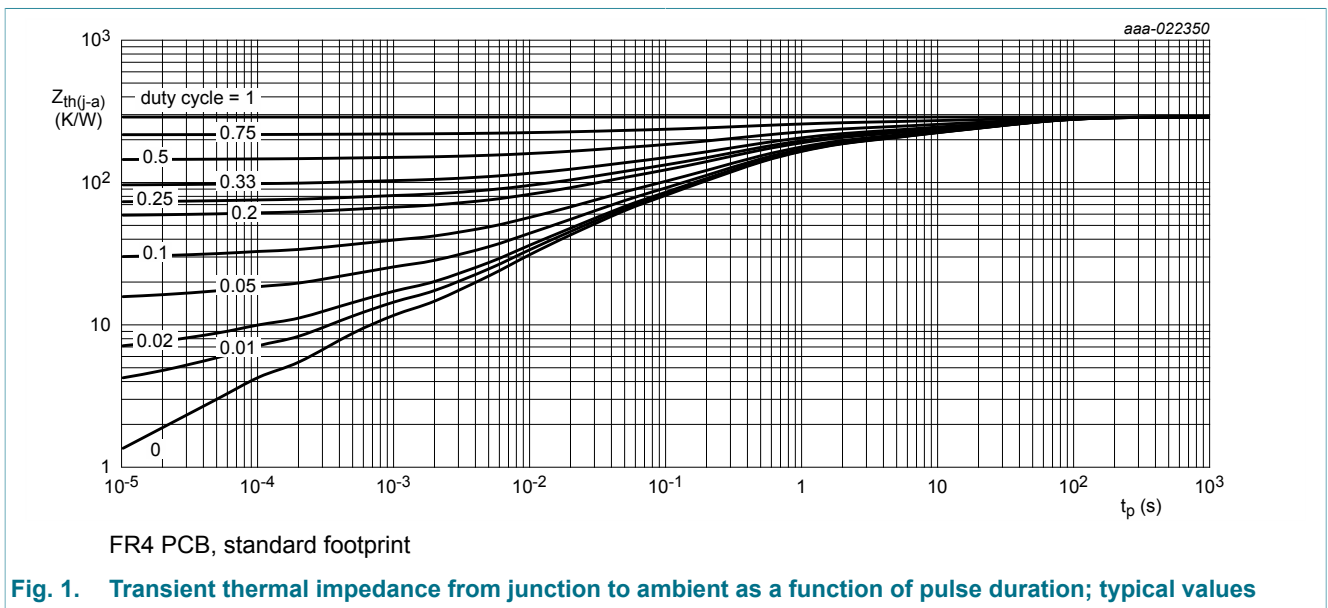
[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode 1 cm<sup>2</sup>.

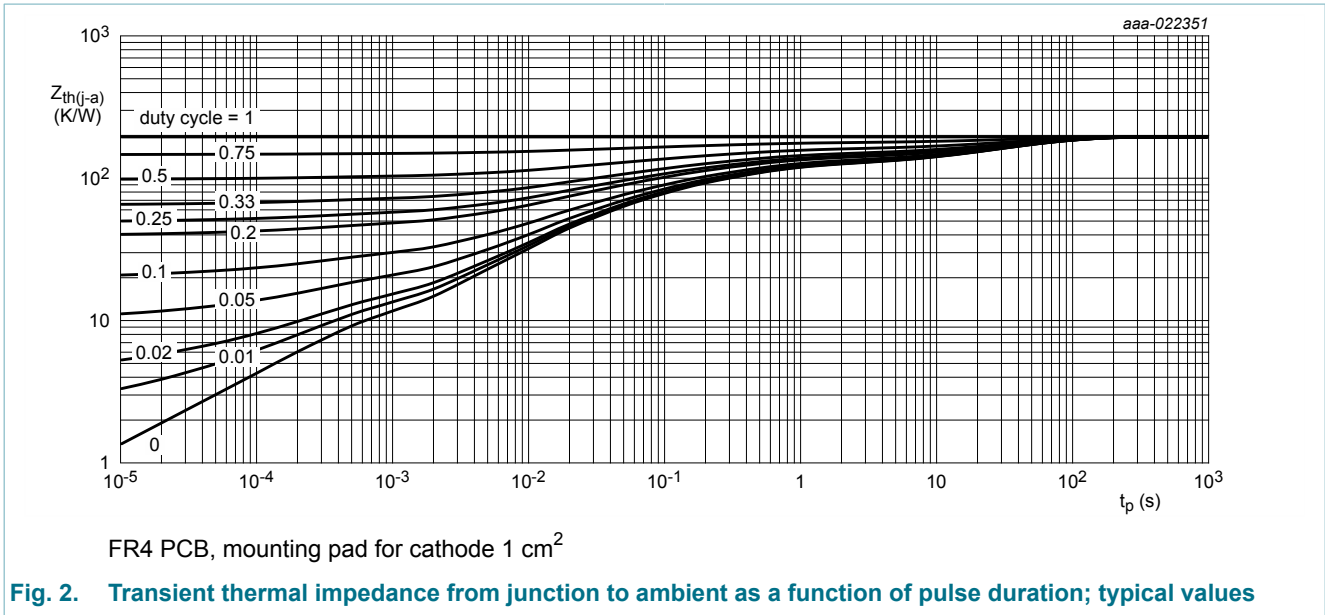
## 8. Thermal characteristics

Table 6. Thermal characteristics

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air	[1][2]	-	-	330	K/W
			[1][3]	-	-	225	K/W
$R_{th(j-sp)}$	thermal resistance from junction to solder point		[4]	-	-	45	K/W

- [1] For Schottky barrier diodes thermal runaway has to be considered, as in some applications the reverse power losses  $P_R$  are a significant part of the total power losses.
- [2] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.
- [3] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for cathode  $1\text{ cm}^2$ .
- [4] Soldering point of cathode tab.

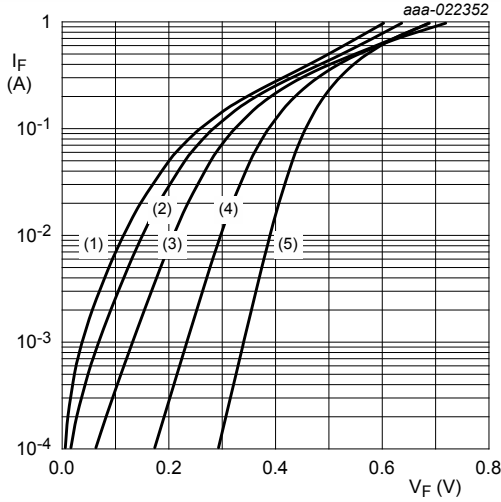




## 9. Characteristics

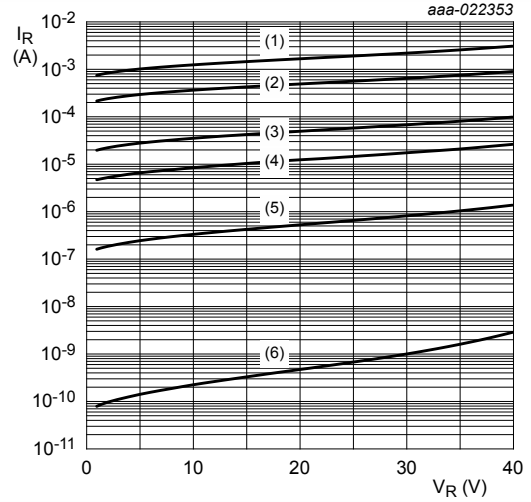
Table 7. Characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$V_{(BR)R}$	reverse breakdown voltage	$I_R = 1 \text{ mA}; t_p \leq 300 \text{ }\mu\text{s}; \delta \leq 0.02;$ $T_j = 25 \text{ }^\circ\text{C};$ pulsed	40	-	-	V
$V_F$	forward voltage	$I_F = 10 \text{ mA}; t_p \leq 300 \text{ }\mu\text{s}; \delta \leq 0.02 ;$ $T_j = 25 \text{ }^\circ\text{C}$	-	300	380	mV
		$I_F = 100 \text{ mA}; t_p \leq 300 \text{ }\mu\text{s}; \delta \leq 0.02 ;$ $T_j = 25 \text{ }^\circ\text{C}$	-	390	470	mV
		$I_F = 250 \text{ mA}; t_p \leq 300 \text{ }\mu\text{s}; \delta \leq 0.02 ;$ $T_j = 25 \text{ }^\circ\text{C}$	-	455	540	mV
		$I_F = 500 \text{ mA}; t_p \leq 300 \text{ }\mu\text{s}; \delta \leq 0.02 ;$ $T_j = 25 \text{ }^\circ\text{C}$	-	550	640	mV
		$I_F = 750 \text{ mA}; t_p \leq 300 \text{ }\mu\text{s}; \delta \leq 0.02 ;$ $T_j = 25 \text{ }^\circ\text{C}$	-	640	740	mV
$I_R$	reverse current	$V_R = 30 \text{ V};$ pulsed; $T_j = 25 \text{ }^\circ\text{C}$	-	1	5	$\mu\text{A}$
		$V_R = 40 \text{ V};$ pulsed; $T_j = 25 \text{ }^\circ\text{C}$	-	1.5	8	$\mu\text{A}$
		$V_R = 40 \text{ V};$ pulsed; $T_j = 65 \text{ }^\circ\text{C}$	-	30	900	$\mu\text{A}$
		$V_R = 5 \text{ V};$ pulsed; $T_j = 125 \text{ }^\circ\text{C}$	-	290	700	$\mu\text{A}$
		$V_R = 40 \text{ V};$ pulsed; $T_j = 125 \text{ }^\circ\text{C}$	-	1	8	mA
$C_d$	diode capacitance	$V_R = 10 \text{ V}; f = 1 \text{ MHz}; T_j = 25 \text{ }^\circ\text{C}$	-	9	12	pF



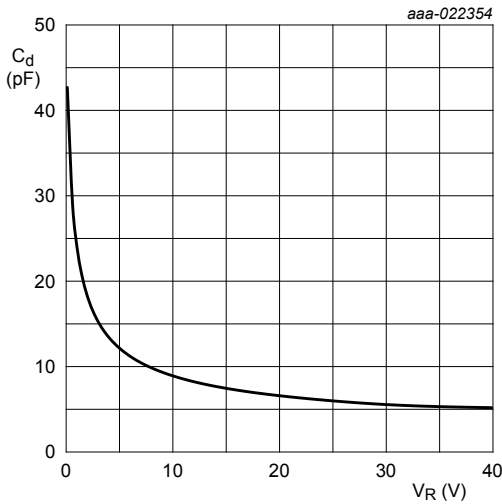
pulsed condition  
 (1)  $T_j = 150\text{ }^\circ\text{C}$   
 (2)  $T_j = 125\text{ }^\circ\text{C}$   
 (3)  $T_j = 85\text{ }^\circ\text{C}$   
 (4)  $T_j = 25\text{ }^\circ\text{C}$   
 (5)  $T_j = -40\text{ }^\circ\text{C}$

**Fig. 3. Forward current as a function of forward voltage; typical values**



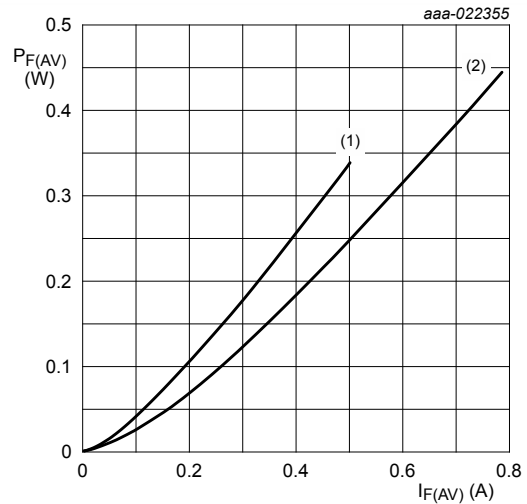
pulsed condition  
 (1)  $T_j = 150\text{ }^\circ\text{C}$   
 (2)  $T_j = 125\text{ }^\circ\text{C}$   
 (3)  $T_j = 85\text{ }^\circ\text{C}$   
 (4)  $T_j = 65\text{ }^\circ\text{C}$   
 (5)  $T_j = 25\text{ }^\circ\text{C}$   
 (6)  $T_j = -40\text{ }^\circ\text{C}$

**Fig. 4. Reverse current as a function of reverse voltage; typical values**



$f = 1\text{ MHz}; T_{amb} = 25\text{ }^\circ\text{C}$

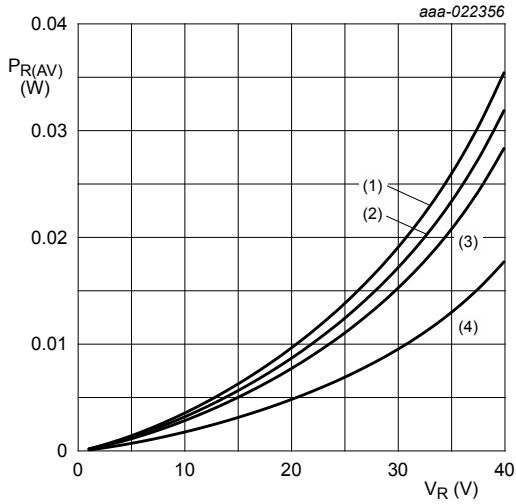
**Fig. 5. Diode capacitance as a function of reverse voltage; typical values**



$T_j = 150\text{ }^\circ\text{C}$   
 (1)  $\delta = 0.5$  sinusoidal  
 (2)  $\delta = 1$

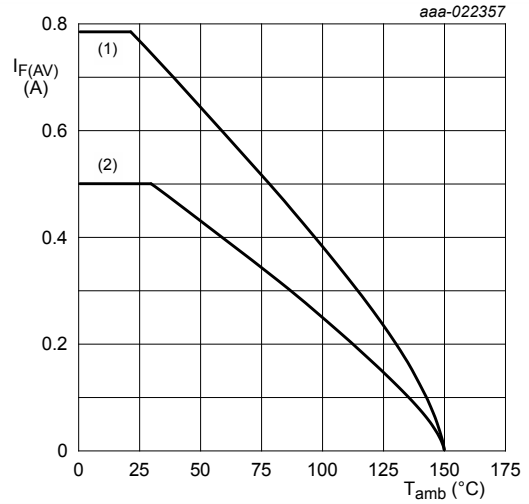
**Fig. 6. Average forward power dissipation as a function of average forward current; typical values**

40 V, 0.75 A medium power Schottky barrier rectifier



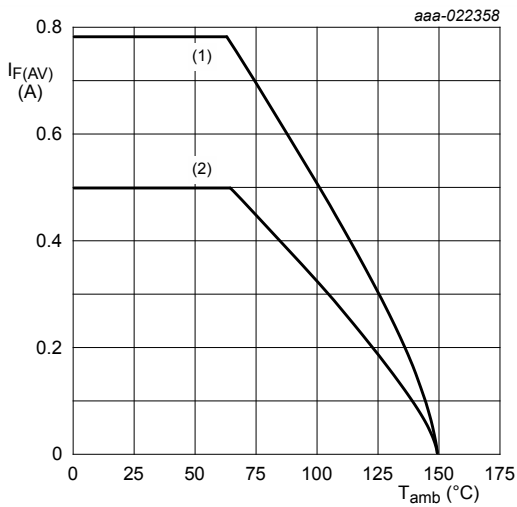
$T_j = 125\text{ }^\circ\text{C}$   
 (1)  $\delta = 1$ ; DC  
 (2)  $\delta = 0.9$ ;  $f = 20\text{ kHz}$   
 (3)  $\delta = 0.8$ ;  $f = 20\text{ kHz}$   
 (4)  $\delta = 0.5$ ;  $f = 20\text{ kHz}$

**Fig. 7.** Average reverse power dissipation as a function of reverse voltage; typical values



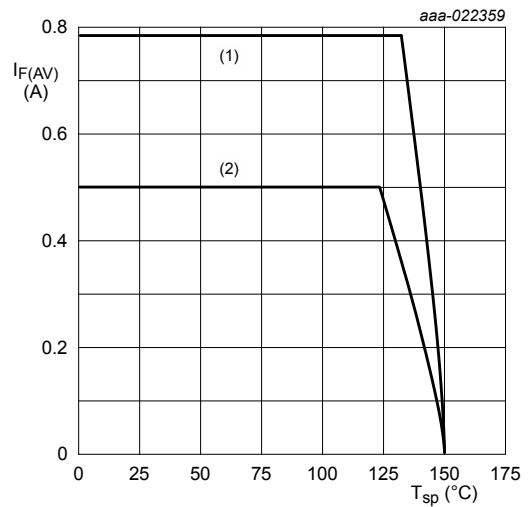
FR4 PCB, standard footprint  
 $T_j = 150\text{ }^\circ\text{C}$   
 (1)  $\delta = 1$ ; DC  
 (2)  $\delta = 0.5$ ;  $f = 50\text{ Hz}/60\text{ Hz}$ ; pulsed sinusoidal

**Fig. 8.** Average forward current as a function of ambient temperature; typical values



FR4 PCB, mounting pad for cathode  $1\text{ cm}^2$   
 $T_j = 150\text{ }^\circ\text{C}$   
 (1)  $\delta = 1$ ; DC  
 (2)  $\delta = 0.5$ ;  $f = 50\text{ Hz}/60\text{ Hz}$ ; pulsed sinusoidal

**Fig. 9.** Average forward current as a function of ambient temperature; typical values



$T_j = 150\text{ }^\circ\text{C}$   
 (1)  $\delta = 1$ ; DC  
 (2)  $\delta = 0.5$ ;  $f = 50\text{ Hz}/60\text{ Hz}$ ; pulsed sinusoidal

**Fig. 10.** Average forward current as a function of solder point temperature; typical values

## 10. Test information

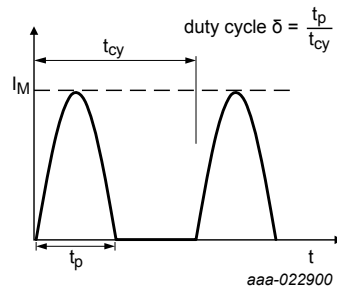


Fig. 11. Duty cycle definition: sinusoidal

The current ratings for the sinusoidal waveforms are calculated according to the equations:  $I_{F(AV)} = I_M \times 0.3183$  with  $I_M$  defined as peak current,  $I_{RMS} = I_{F(AV)}$  at DC, and  $I_{RMS} = I_M \times \sqrt{(\delta/2)}$  with  $I_{RMS}$  defined as RMS current.

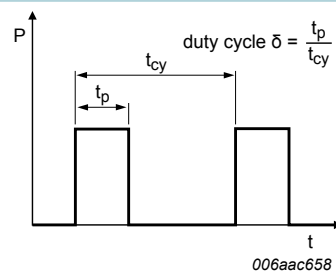


Fig. 12. Duty cycle definition: square wave

### 10.1 Quality information

This product has been qualified in accordance with the Automotive Electronics Council (AEC) standard Q101 - Stress test qualification for discrete semiconductors, and is suitable for use in automotive applications.

## 11. Package outline

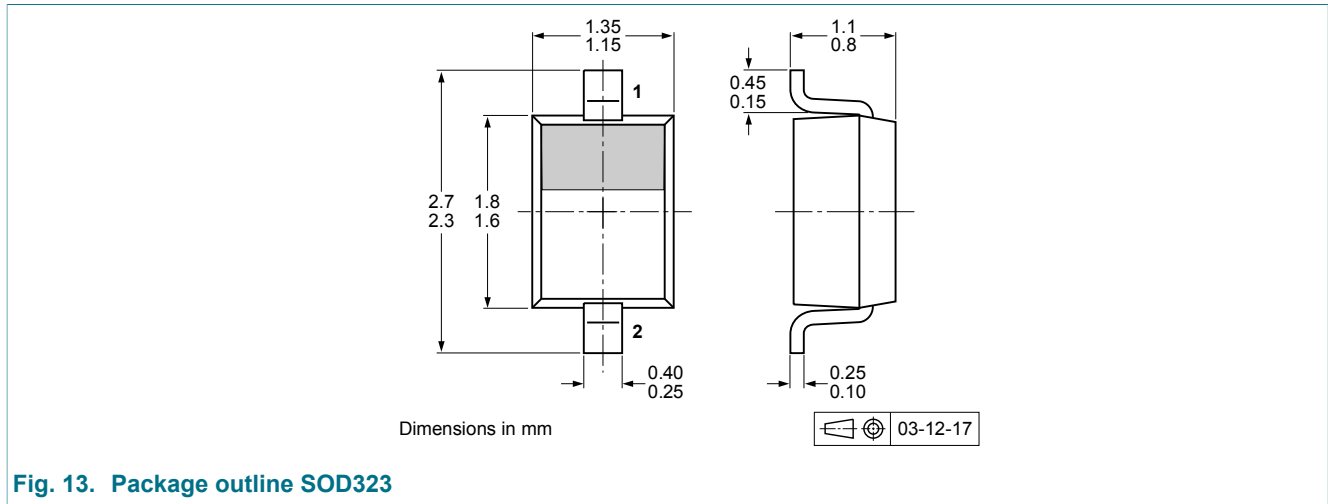


Fig. 13. Package outline SOD323

## 12. Soldering

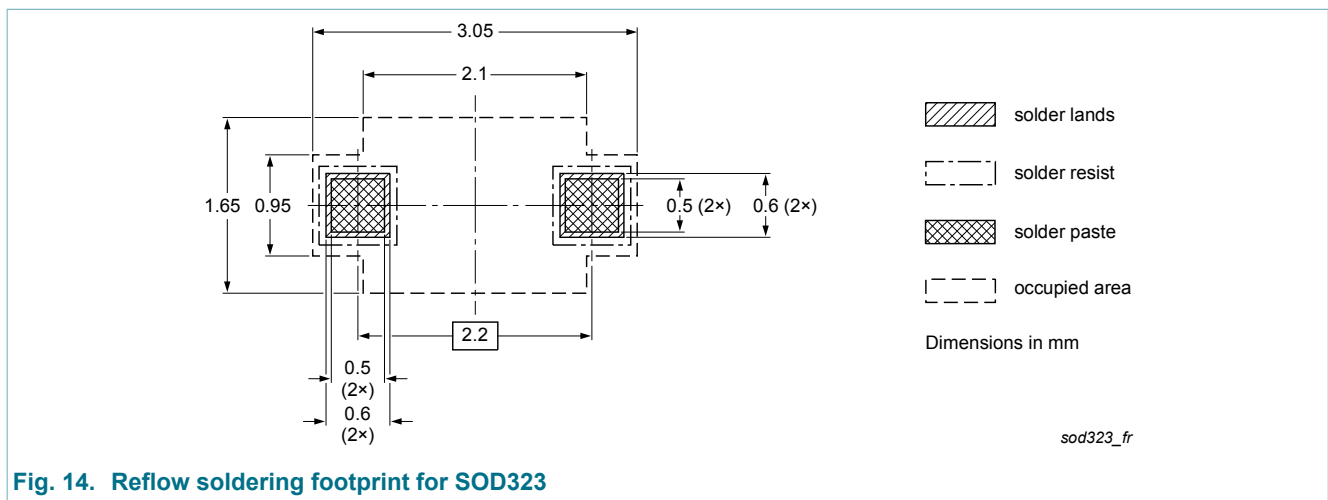
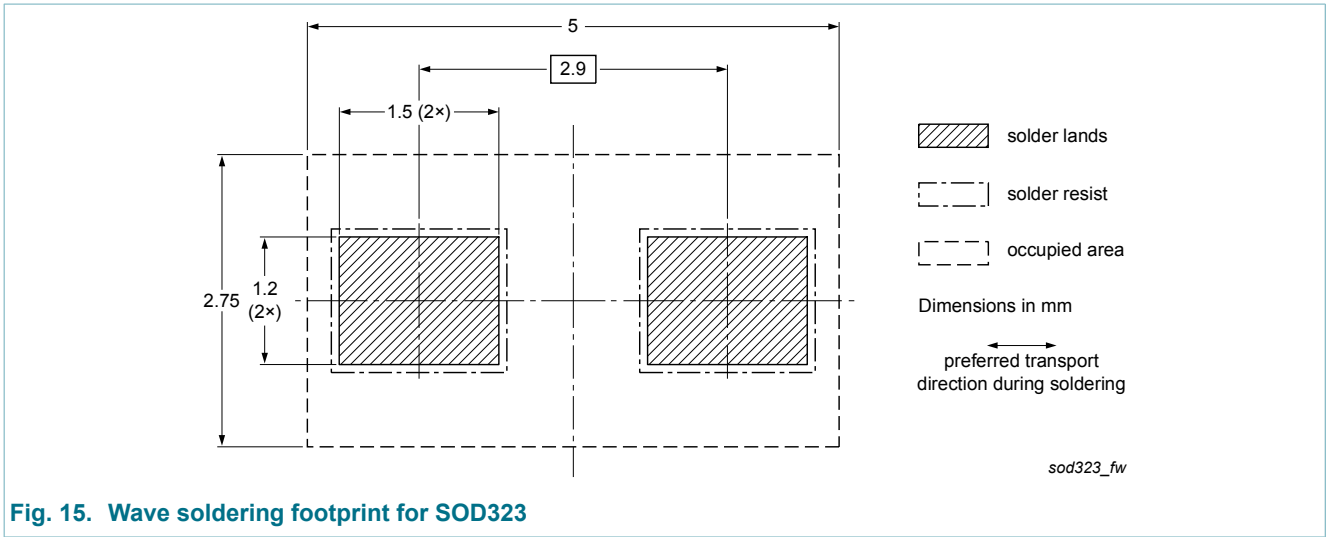


Fig. 14. Reflow soldering footprint for SOD323





## 13. Revision history

Table 8. Revision history

Data sheet ID	Release date	Data sheet status	Change notice	Supersedes
BAT165A v.1	20160502	Product data sheet	-	-

## 14. Legal information

### 14.1 Data sheet status

Document status [1][2]	Product status [3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
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